

Description: 860-930MHz Embedded Helical Antenna

PART NUMBER: W3136

Series: SMD Helical Antenna



Features:

- 860-930MHz
- Impedance 50 Ohm
- Plastic support helical antenna
- Length 29.5mm,
- Gain 2dBi
- SMD Mounting on PCB
- RoHS Compliant

Applications:

- 868MHz and 915MHz ISM **Band Systems**
- IoT systems
- Metering, Automation
- Security, surveillance
- Remote controls, toys

All dimensions are in mm / inches

Issue: 1943

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Pulse/Larsen Antennas 18110 SE 34th St Bldg 2 Suite 250 Vancouver, WA 98683

Europe Headquarters Pulse GmbH & Do, KG Zeppelinstrasse 15 Herrenberg, Germany Tel: 1-360-944-7551 Downloaded From Oneyac.com

Pulse (Suzhou) Wireless Products Co, Inc. 99 Huo Ju Road(#29 Bldg,4th Phase Suzhou New District Jiangsu Province, Suzhou 215009 PR China Tel: 86 512 6807 9998



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ELECTRICAL SPECIFICATIONS

Antenna Type Helical monopole Frequency 860-930MHz Nominal Impedance 50Ω **VSWR** Max 2.5 Radiation Pattern **Omni** Gain 2 dBi Efficiency 65% Polarization Linear **Power Withstanding** 2W

MECHANICAL SPECIFICATIONS

Overall Length 29.5mm
Weight 2.52g
Antenna Color / Material White
Fix system SMD+Glue

Recommended Glue Resinlab EP1320LV Black

Solder Paste Thickness Min 0.15mm

MSL 3

ENVIRONMENTAL SPECIFICATIONS

Operating Temperature -40° C~+85° C Storage Temperature -40° C~+85° C

RoHS Compliant Yes

OTHER SPECIFICATIONS

Issue: 1943

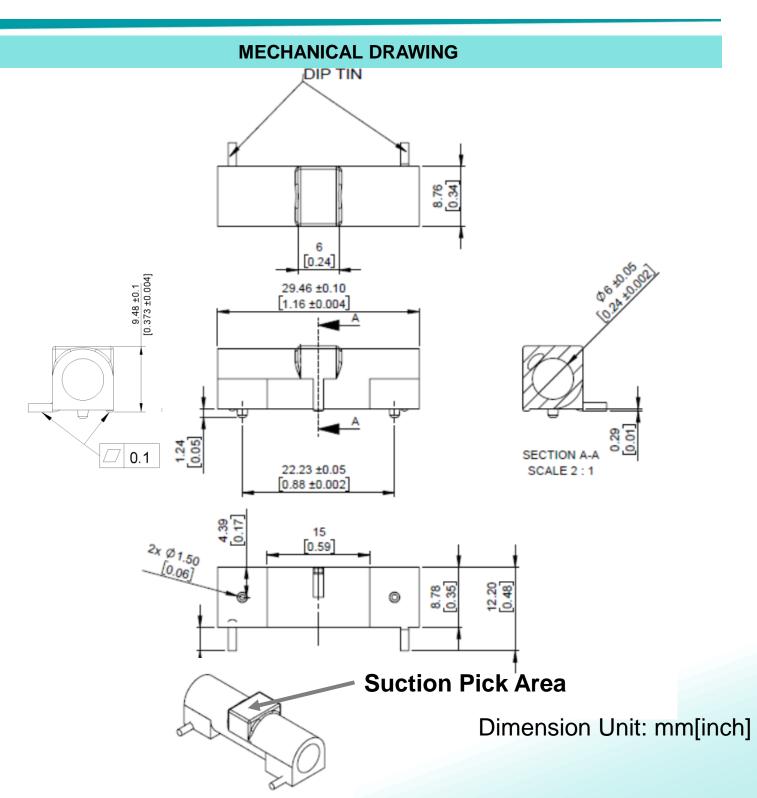




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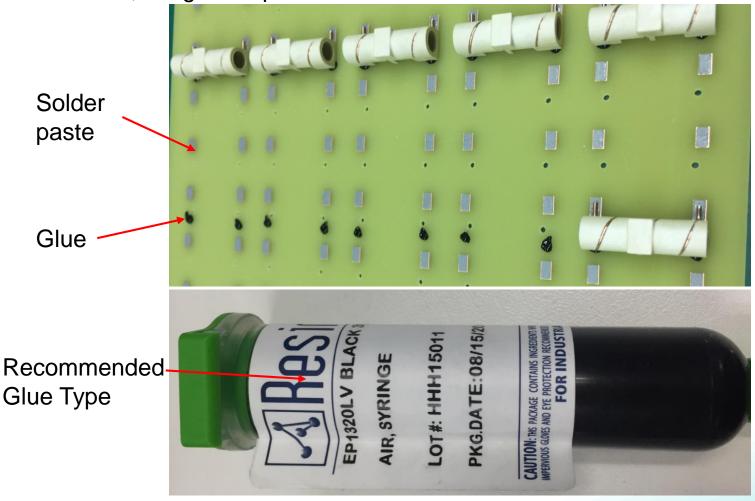
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FIX SYSTEM RECOMMENDATION

Fix system

- 1. SMD process
- 2. Solder paste thickness: minimum 0.15mm
- 3. Glue is required, Recommended Glue: Resinlab EP1320LV Black, usage and position see below recommended area.









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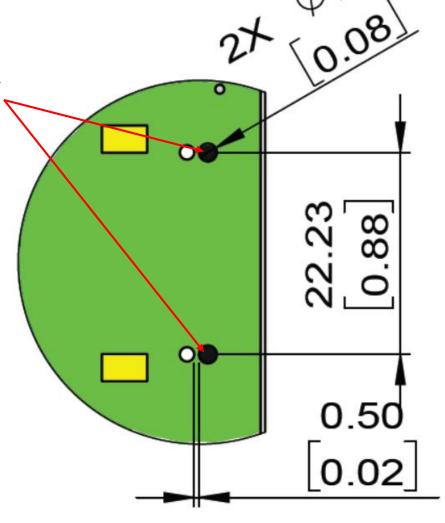
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FIX SYSTEM RECOMMENDATION

Fix system

1. Glue position on PCB for recommendation

Glue position on PCB for recommendation



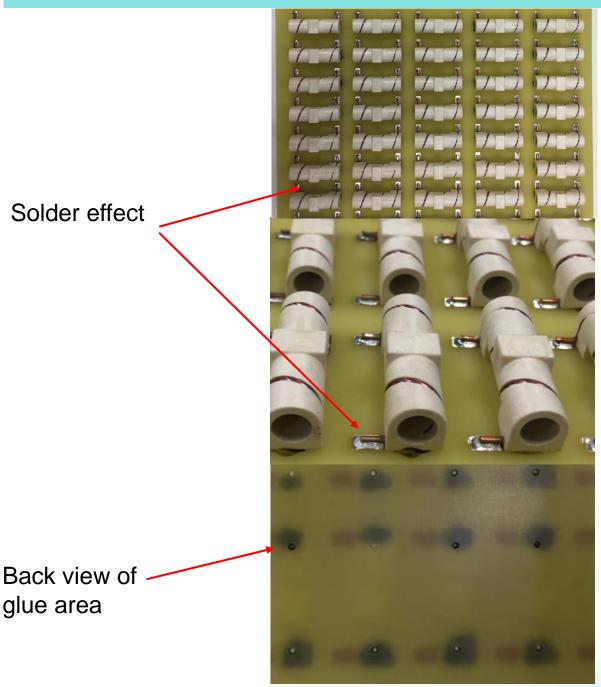


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FIX SYSTEM RECOMMENDATION



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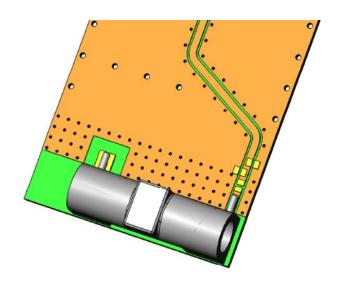
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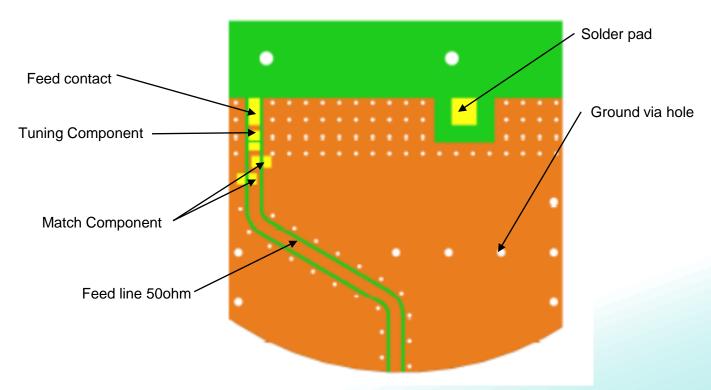
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TEST SETUP

PWB Layout for W3136 SMD Helical Antenna





Issue: 1943

ROHS



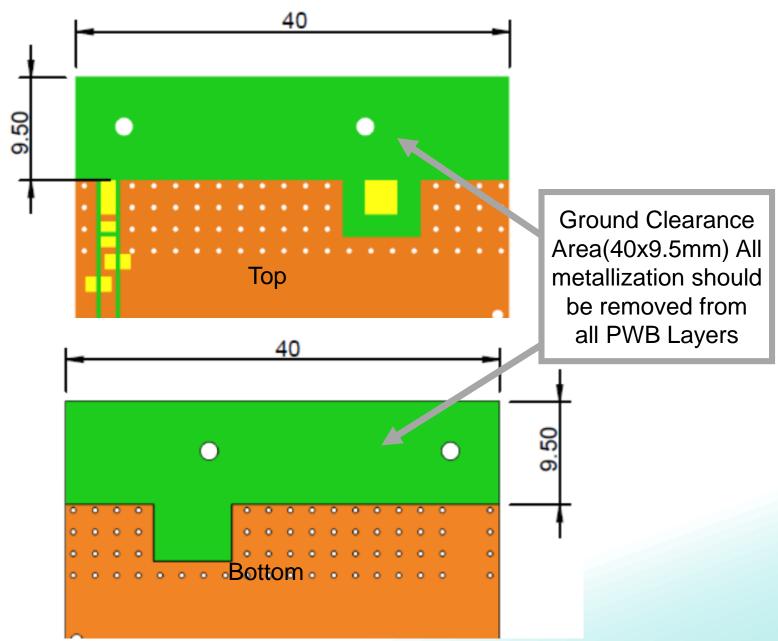
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TEST SETUP

PWB ground clearance area (Top):40x9.5mm PWB ground clearance area (Bottom):40x9.5mm



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ROHS



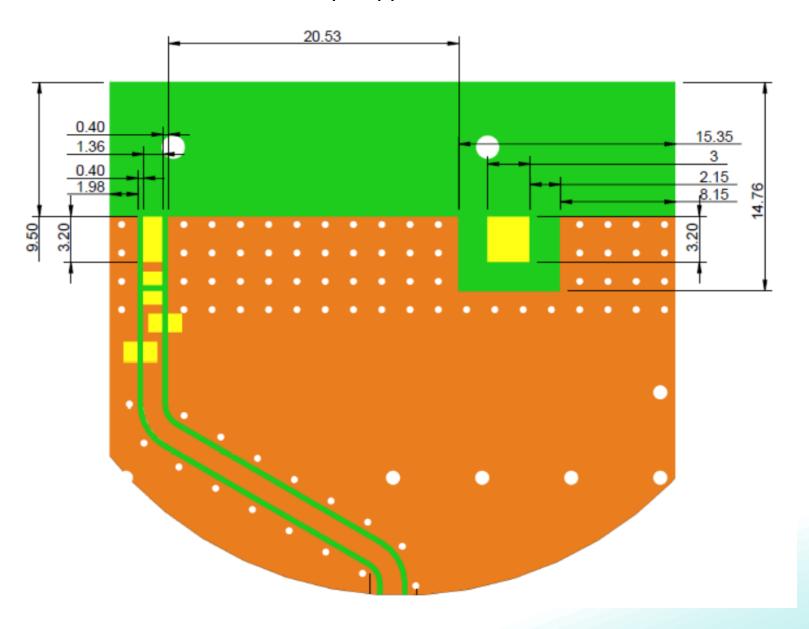
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TEST SETUP

PWB Pad dimension in top copper







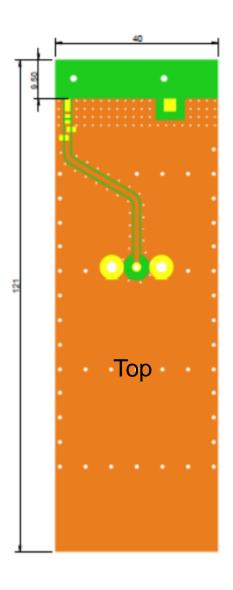
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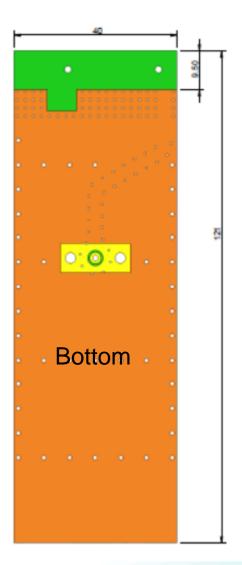
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TEST SETUP

PWB Layout, Pulse PWB size:121x40mm, Thickness 1.0mm, other size boards can be used depending on customer size.







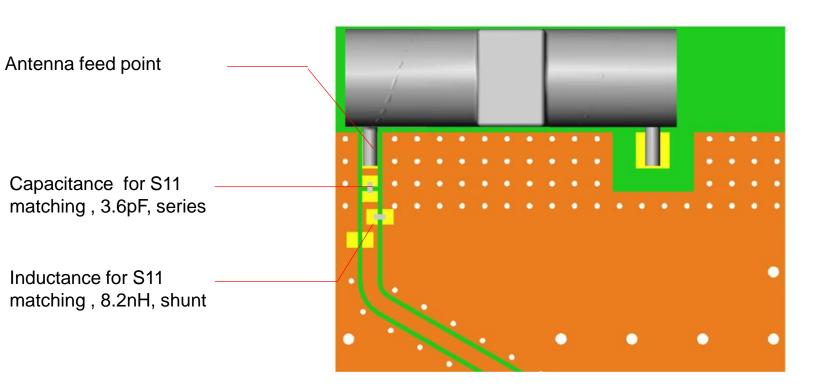
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TEST SETUP

PWB Layout, Pulse PWB size:121x40mm, Thickness 1.0mm, other size boards can be used depending on customer size.



Note: Exact matching and tuning components value depend on application, board size, cover etc.



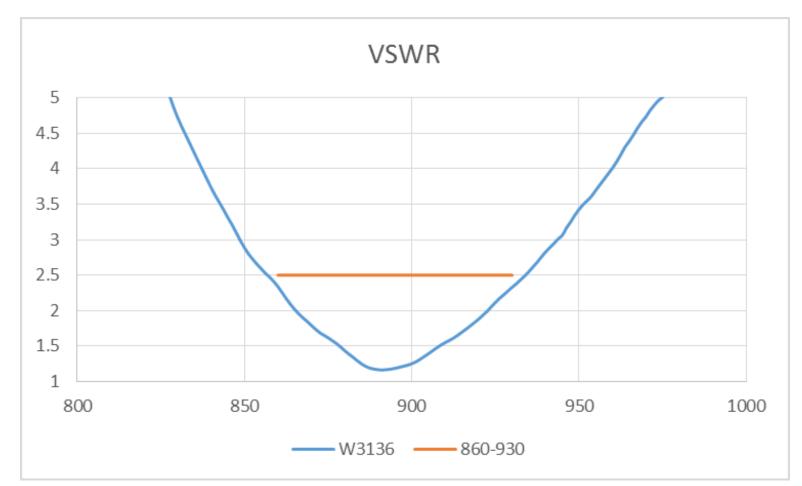
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CHARTS

Measured on the 121x40mm test board with tuning and matching circuit







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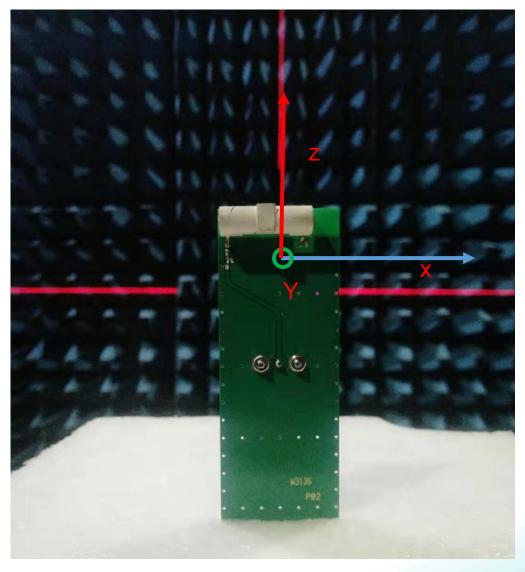
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TEST SETUP

Measured on the 121x40mm test board with tuning and matching circuit.

Test in PSU China Chamber.



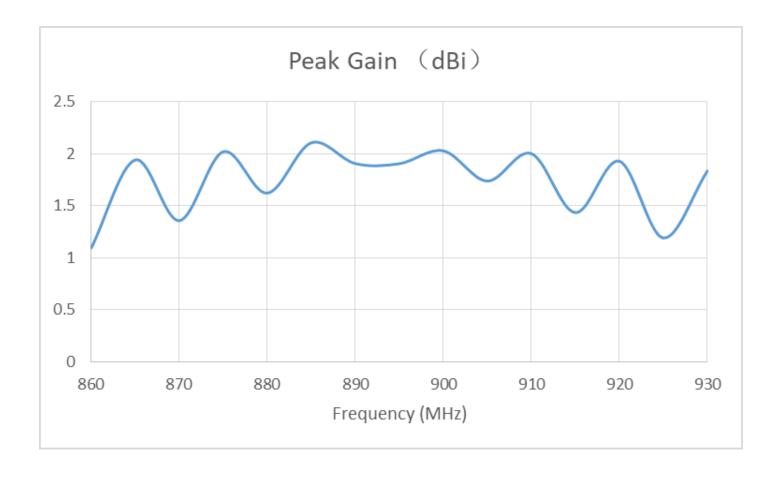


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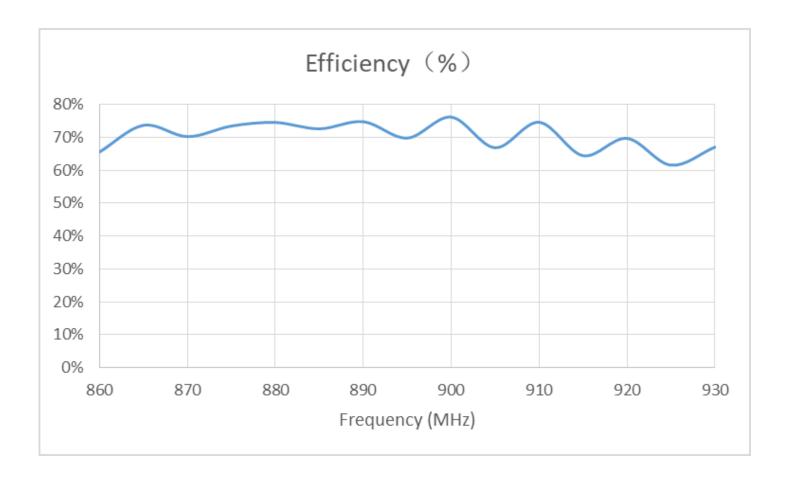


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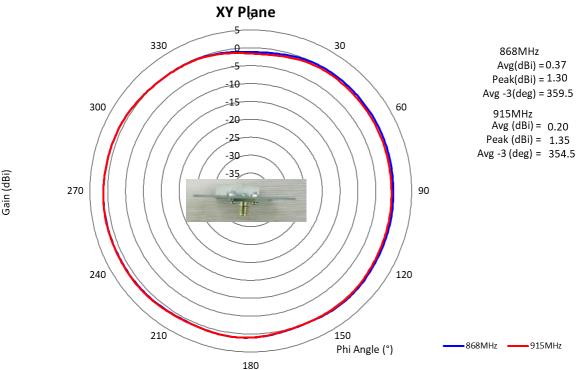
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CHARTS

Typical radiation pattern in free space







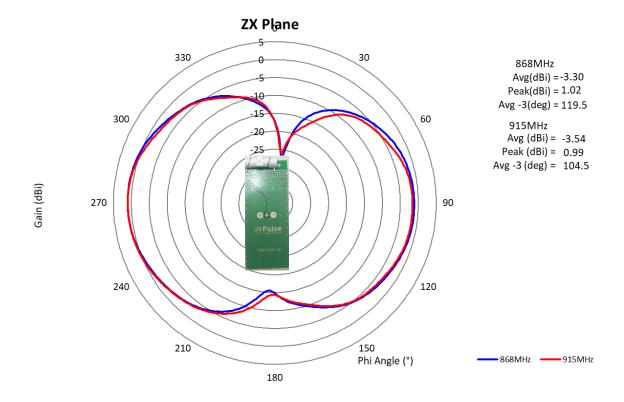
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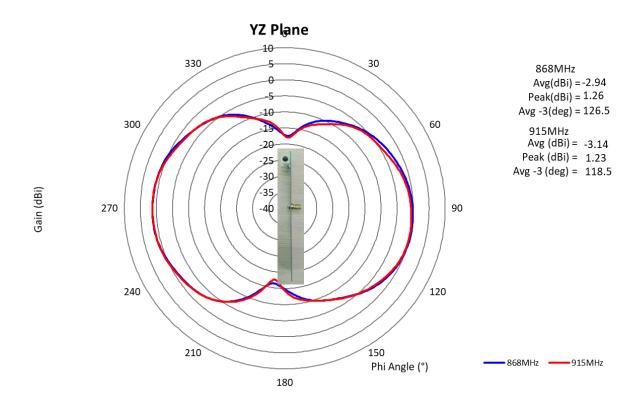
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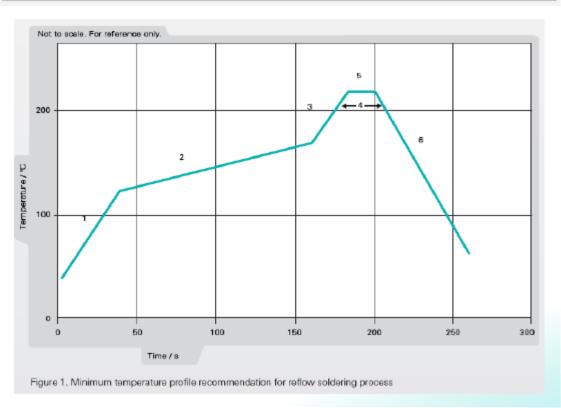
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Recommendation for reflow soldering process

Printing stencil thickness 0,15 - 0,25 mm is recommended for the solder paste. The maximum soldering temperature should not exceed 260°C. The temperature profile recommendations for reflow soldering process is presented in the Figures 1 and 2. The reflow profile presented in figure 1 describes minimum reflow temperatures. The reflow profile presented in figure 2 describes maximum reflow temperatures. located at the center of the coverage area.

	Method of heat transfer	Controlled hot air convection
1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 30 sec
5	Peak temperature in reflow	230 ℃ for 10 seconds
6	Temperature gradient in cooling	Max -5 °C/s





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1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 60 sec
5	Time above 230 °C	Max 50 sec
6	Time above 250 °C	Max 10 sec
7	Peak temperature in reflow	260 ℃ for 5 seconds
8	Temperature gradient in cooling	Max -5 °C/s

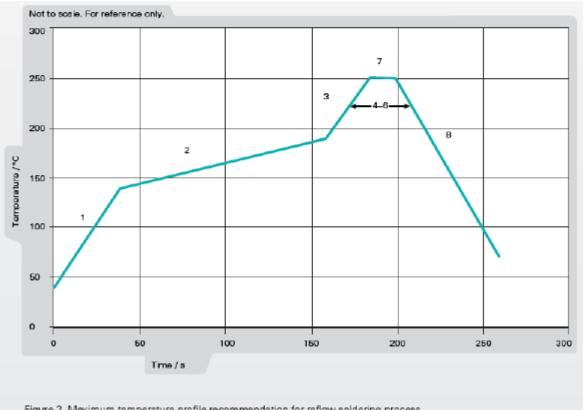


Figure 2. Maximum temperature profile recommendation for reflow soldering process



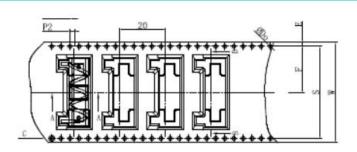


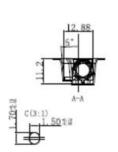
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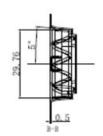
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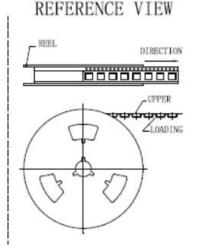
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PACKAGING









All the size design with reference to the EIA - 481 - C - 2003.

6. Loading within 250 mm length maximum curvature is less than



Notes:

1. 10 side hole of the cumulative tolerance cannot be more than + / - 0.2 mm.

Material specifications: PS black antistatic, thickness of 0.50 mm.

3.13 inches (100) axis reel package length: 4.6 m. (the front air bag length: 0.33 m, parts packing length: 4 m, after a period of empty packet length: 0.33 meters).

4.13 inches (100) axis reel packaging components to the total number of stars: 230. (the front air bag star count: 15, actual packing parts the number: 200, after a period of empty bag star count: 15).

230PCS

13"/44

200PCS

Manufacture Data

Total PCS

Package Q

Reel

Total 200 PCS In Reel

Reel Size: 330MM[13INCH]

Total 2 PCS Reel In Package Box

Package Box Size:350x350x120mm

单击下面可查看定价,库存,交付和生命周期等信息

>>Pulse(普思)